



Product Change Notification

Change Notification #: 117109 - 00

Change Title: Intel® Server Chassis H2204XXLRE, PCN 117109-00, Label, BSMI label update

Date of Publication: August 9, 2019

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:*	August 26, 2019
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*Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following change on the Intel® Server Chassis H2204XXLRE:

- Update of the label of the 2130W Power Supply included Intel® Server Chassis H2204XXLRE to comply with BSMI RoHS mark.

Power Supply Label before (changes in red):

Power Supply Label after (changes in red):

The image shows a power supply label with several red boxes highlighting changes. The main text includes 'SWITCHING POWER SUPPLY' and '交換式電源供應器'. The input/output specifications are listed as 100-127V-12A and 200-240V-10A. The power output is 1370W MAX. The label also features various certification logos (CE, FCC, RoHS, etc.) and a barcode with the P/N: H66158-014. The model number is PSSF22201A.

The image shows the updated power supply label. The main text is the same, but the power output is now 2130W MAX. The model number is updated to PSSF22201A. The label also features various certification logos (CE, FCC, RoHS, etc.) and a barcode with the P/N: H66158-015. The model number is PSSF22201A.

Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes but encourages customers to understand the change and determine the impact on their applications.

Therefore Intel recommends that the customer perform a standard level of evaluation. Latest BIOS/ME/Integrated BMC and FRUSDR packages and release notes can be download from <http://www.intel.com/support>.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
H2204XXLRE	957322	J32925-010	J32925-011

PCN Revision History:

Date of Revision:

August 9, 2019

Revision Number:

00

Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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